



Microwave solutions for the next generation in advanced materials processing

VFM TECHNICAL DATA SHEET ELECTRONIC MATERIALS INC. DIEBOND 4460 LP

ADHESIVE PROPERTIES (As reported by manufacturer)

Color: White / Amber
Viscosity (cP): 9000
Tg Measured by DSC (°C): N/A
Tg Measured by TMA (°C): 110
CTE Below Tg (ppm/°C): 60
CTE Above Tg (ppm/°C): 150

RECOMMENDED VFM CURE

VFM Cure Profile: 15 Minutes @ 125°C

Compared to Manufacturer's Suggested
Convection Oven Cure Profile: 30 Minutes @ 125°C

DSC COMPARISON

EMI Diebond 4460 LP

